

| # | Layer | Thickness | Description | Dk | Df | Note |
|---------------------------------|---------------|-----------|---|-----|-------|-----------------------------|
| | Top Solder | 0.015mm | Soldermask IPC-SM840 | 3,5 | 0,028 | used on rigid parts |
| 1 | Top Side | 0.030mm | Starting foil 1/4oz. after plating and processing | | | |
| | | 0.065mm | Prepreg IPC-4101/127/128 | 3,5 | 0,011 | FR-4.1 filled, halogen free |
| 2 | Inner Layer 1 | 0.035mm | ED Base Copper | | | |
| | | 0.610mm | Core IPC-4101/127/128 | 5 | 0,011 | FR-4.1 filled, halogen free |
| 3 | Inner Layer 2 | 0.035mm | ED Base Copper | | | |
| | | 0.125mm | Prepreg IPC-4101/127/128 | 3,7 | 0,011 | FR-4.1 filled, halogen free |
| 4 | Inner Layer 3 | 0.035mm | ED Base Copper | | | |
| | | 0.610mm | Core IPC-4101/127/128 | 5 | 0,011 | FR-4.1 filled, halogen free |
| 5 | Inner Layer 4 | 0.035mm | ED Base Copper | | | |
| | | 0.065mm | Prepreg IPC-4101/127/128 | 3,5 | 0,011 | FR-4.1 filled, halogen free |
| 6 | Bottom Side | 0.030mm | Starting foil 1/4oz. after plating and processing | | | |
| | Bottom Solder | 0.015mm | Soldermask IPC-SM840 | 3,5 | 0,028 | used on rigid parts |
| Total thickness: 1.705mm | | | | | | |

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:
▶ www.we-online.com

HDI6_1-4-1_1,70_35_V2.12

PCB Thickness Tolerance: ± 10%

| customer | created |
|----------|---------------|
| pcb name | approved |
| engineer | format |
| date | A4, landscape |

Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen

